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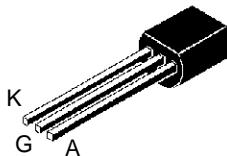
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## SENSITIVE GATE SCR

### FEATURES

- $I_T(\text{RMS}) = 1.25\text{A}$
- $V_{\text{DRM}} = 200\text{V}$  to  $800\text{V}$
- Low  $I_{\text{GT}} < 200 \mu\text{A}$



**TO92**  
(Plastic)

### DESCRIPTION

The X02xxxA series of SCRs uses a high performance TOP GLASS PNPN technology. These parts are intended for general purpose applications where low gate sensitivity is required.

### ABSOLUTE RATINGS (limiting values)

| Symbol                    | Parameter  | Value                      | Unit                   |
|---------------------------|--|----------------------------|------------------------|
| $I_T(\text{RMS})$         | RMS on-state current<br>( $180^\circ$ conduction angle)  | 1.25                       | A                      |
| $I_T(\text{AV})$          | Mean on-state current<br>( $180^\circ$ conduction angle)   | 0.8                        | A                      |
| $I_{TSM}$                 | Non repetitive surge peak on-state current<br>( $T_j$ initial = $25^\circ\text{C}$ )                     | tp = 8.3 ms                | A                      |
|                           |  | tp = 10 ms                 |                        |
| $I^2t$                    | $I^2t$ Value for fusing  | 2.5                        | $\text{A}^2\text{s}$   |
| $dI/dt$                   | Critical rate of rise of on-state current<br>$I_G = 10 \text{ mA}$ $di/dt = 0.1 \text{ A}/\mu\text{s}$ . | 30                         | $\text{A}/\mu\text{s}$ |
| $T_{\text{stg}}$<br>$T_j$ | Storage and operating junction temperature range   | - 40, + 150<br>- 40, + 125 | $^\circ\text{C}$       |
| TI                        | Maximum lead temperature for soldering during 10s at 2mm from case                                       | 260                        | $^\circ\text{C}$       |

| Symbol                               | Parameter  | Voltage |     |     |     | Unit |
|--------------------------------------|--|---------|-----|-----|-----|------|
|                                      |  | B       | D   | M   | N   |      |
| $V_{\text{DRM}}$<br>$V_{\text{RRM}}$ | Repetitive peak off-state voltage<br>$T_j = 125^\circ\text{C}$ $R_{\text{GK}} = 1\text{K}\Omega$ | 200     | 400 | 600 | 800 | V    |

## X02xxxA

### THERMAL RESISTANCES

| Symbol               | Parameter                | Value | Unit |
|----------------------|--------------------------|-------|------|
| R <sub>th(j-a)</sub> | Junction to ambient      | 150   | °C/W |
| R <sub>th(j-l)</sub> | Junction to leads for DC | 60    | °C/W |

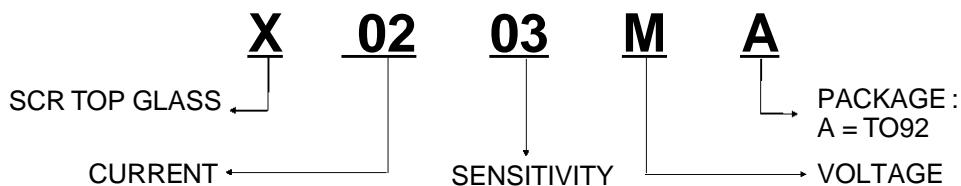
### GATE CHARACTERISTICS (maximum values)

P<sub>G(AV)</sub>= 0.2 W P<sub>GM</sub> = 3 W (tp = 20 μs) I<sub>GM</sub> = 1.2 A (tp = 20 μs)

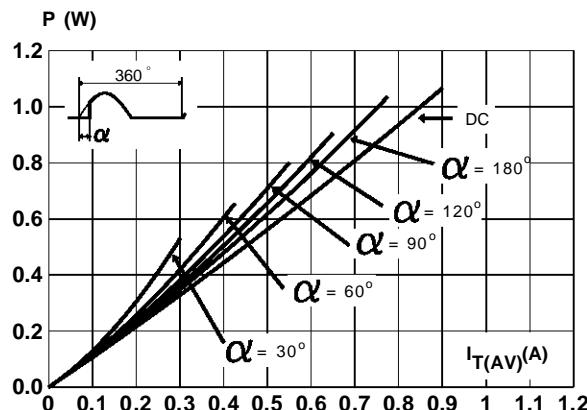
### ELECTRICAL CHARACTERISTICS

| Symbol                               | Test Conditions   | Sensitivity            |     |          | Unit  |
|--------------------------------------|---|------------------------|-----|----------|-------|
|                                      |   | 02                     | 03  | 05       |       |
| I <sub>GT</sub>                      | V <sub>D</sub> =12V (DC) R <sub>L</sub> =140Ω   | T <sub>j</sub> = 25°C  | MIN |          | 20 20 |
|                                      |   |                        | MAX | 200 200  | 50    |
| V <sub>GT</sub>                      | V <sub>D</sub> =12V (DC) R <sub>L</sub> =140Ω   | T <sub>j</sub> = 25°C  | MAX | 0.8      |       |
| V <sub>GD</sub>                      | V <sub>D</sub> =V <sub>DRM</sub> R <sub>L</sub> =3.3kΩ<br>R <sub>GK</sub> = 1 KΩ  | T <sub>j</sub> = 125°C | MIN | 0.1      |       |
| V <sub>RGM</sub>                     | I <sub>RG</sub> = 10μA  | T <sub>j</sub> = 25°C  | MIN | 8        |       |
| t <sub>gd</sub>                      | V <sub>D</sub> =V <sub>DRM</sub> I <sub>TM</sub> = 3 x I <sub>T(AV)</sub><br>dI <sub>G</sub> /dt = 0.1A/μs I <sub>G</sub> = 10mA                                    | T <sub>j</sub> = 25°C  | TYP | 0.5      |       |
| I <sub>H</sub>                       | I <sub>T</sub> = 50mA R <sub>GK</sub> = 1 KΩ  | T <sub>j</sub> = 25°C  | MAX | 5        |       |
| I <sub>L</sub>                       | I <sub>G</sub> =1mA R <sub>GK</sub> = 1 KΩ  | T <sub>j</sub> = 25°C  | MAX | 6        |       |
| V <sub>TM</sub>                      | I <sub>TM</sub> = 2.5A tp= 380μs  | T <sub>j</sub> = 25°C  | MAX | 1.45     |       |
| I <sub>DRM</sub><br>I <sub>RRM</sub> | V <sub>D</sub> = V <sub>DRM</sub> R <sub>GK</sub> = 1 KΩ<br>V <sub>R</sub> = V <sub>RRM</sub>   | T <sub>j</sub> = 25°C  | MAX | 5        |       |
|                                      |   | T <sub>j</sub> = 110°C | MAX | 200      |       |
| dV/dt                                | V <sub>D</sub> =67%V <sub>DRM</sub> R <sub>GK</sub> = 1 KΩ  | T <sub>j</sub> = 110°C | TYP | 15 20 15 | V/μs  |
| t <sub>q</sub>                       | I <sub>TM</sub> = 3 x I <sub>T(AV)</sub> V <sub>R</sub> =35V<br>dI/dt=10A/μs tp=100μs<br>dV/dt=2V/μs<br>V <sub>D</sub> = 67%V <sub>DRM</sub> R <sub>GK</sub> = 1 KΩ | T <sub>j</sub> = 110°C | MAX | 100      |       |

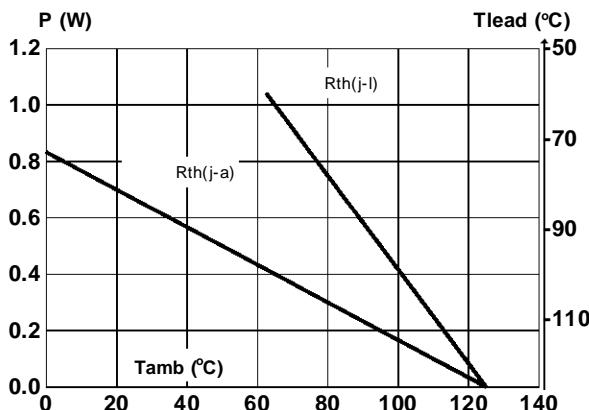
### ORDERING INFORMATION



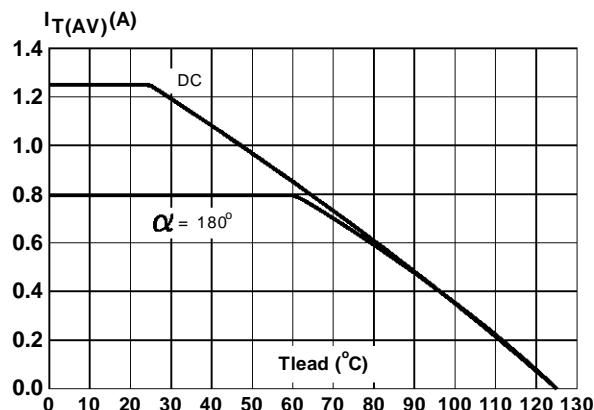
**Fig.1 :** Maximum average power dissipation versus average on-state current.



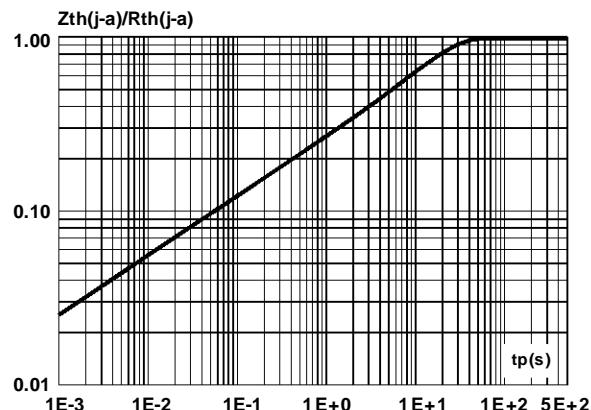
**Fig.2 :** Correlation between maximum average power dissipation and maximum allowable temperature (Tamb and Tlead).



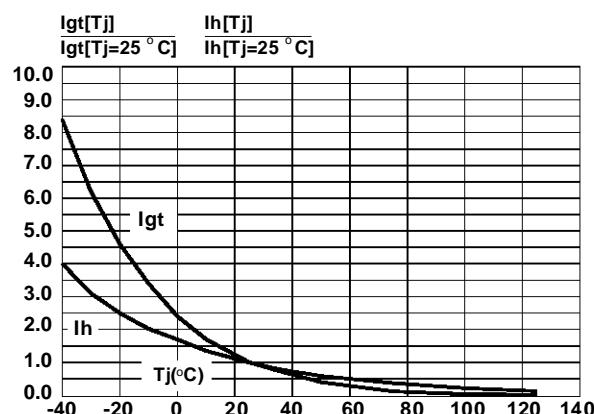
**Fig.3 :** Average on-state current versus lead temperature.



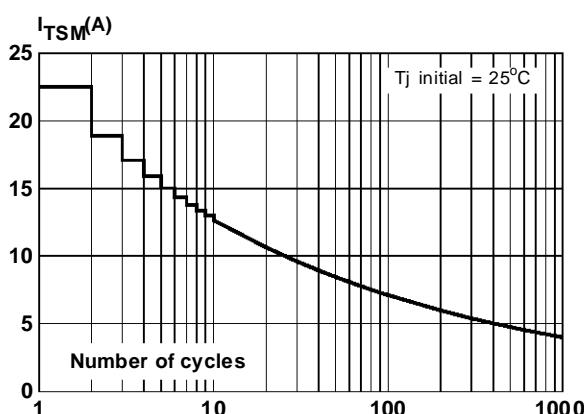
**Fig.4 :** Relative variation of thermal impedance junction to ambient versus pulse duration.



**Fig.5 :** Relative variation of gate trigger current and holding current versus junction temperature.

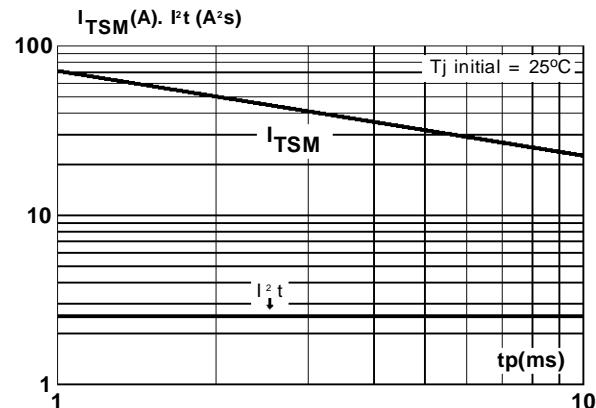


**Fig.6 :** Non repetitive surge peak on-state current versus number of cycles.

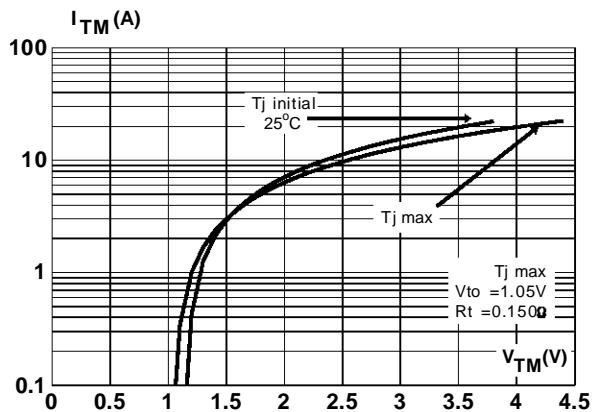


## X02xxxA

**Fig.7 :** Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t_p \leq 10\text{ms}$ , and corresponding value of  $I^2t$ .



**Fig.8 :** On-state characteristics (maximum values).



**PACKAGE MECHANICAL DATA**  
TO92 (Plastic)

| REF. | DIMENSIONS  |      |      |        |       |       |
|------|-------------|------|------|--------|-------|-------|
|      | Millimeters |      |      | Inches |       |       |
|      | Typ.        | Min. | Max. | Typ.   | Min.  | Max.  |
| A    | 1.35        |      |      | 0.053  |       |       |
| B    |             |      | 4.7  |        |       | 0.185 |
| C    | 2.54        |      |      | 0.100  |       |       |
| D    |             | 4.4  | 4.8  |        | 0.173 | 0.189 |
| E    |             | 12.7 |      |        | 0.500 |       |
| F    |             |      | 3.7  |        |       | 0.146 |
| a    |             |      | 0.45 |        |       | 0.017 |

Marking : Type number

Weight : 0.2 g

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